

L Number	Hits	Search Text	DB	Time stamp
58	0	((chip or die or wafer) and photresist) near mirror	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/04/07 03:54
59	3	((chip or die or wafer) and photoresist) near mirror	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/04/07 03:58
60	6	((chip or die or wafer) and (protectant or protect)) near mirror	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/04/07 03:59